User’s Guide

Power Supply Design for Renesas R-Car M3 Using LP87565U-Q1, LP873245-Q1, and LP87334A-Q1

ABSTRACT

This document details the design considerations of a power solution for the Renesas R-Car M3x SoC (system-on-chip) power rails using the LP87565-Q1, LP8733-Q1, and LP8732-Q1 power management ICs. Additional TLV733P-Q1 LDOs are used for the peripheral rails. This power solution assumes an input voltage of 5 V (+/-5%). If the system input voltage is higher, for example a car battery, a buck converter as a pre-regulator should be used to generate a supply voltage of 5 V.

The LP87565-Q1 has four buck converters configured to work as dual 2-phase converters. LP8732-Q1 has two 2 A buck converters and two 300 mA LDOs. LP8733-Q1 has two 3 A buck converters and two 300 mA LDOs. These devices are OTP programmable, meaning default register values are set in TI production line to desired values for this platform without further need for customer to change settings. Full orderable part numbers for these OTP spins are LP87565URNFRQ1, LP87334ARHDRQ1, and LP873245RHDRQ1. See the Technical Reference Manuals for the specific part numbers for more details on the OTP settings.

This power solution is an example how R-Car M3x required rails can be powered with TI PMICs. Sequencing is handled through programmable startup/shutdown delays of the PMICs and GPIOs and it only requires a single Enable signal from the system to initiate the sequencing. This power solution is possible to customize and optimize based on the actual use case regarding SoC variant, current requirements, used peripherals, and so forth.

Reference design with TI power solution and R-Car M3W SoC + all needed peripherals, memory, and connections was designed and built to confirm the functionality and performance of the power solution. Design files, software, and documentation are available on request to help integrating TI power solution to customer system. This solution supports fully DVFS and AVS for core rail through i2C bus.

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# Design Parameters

Table 1-1 shows the power rails, load requirements, and startup/shutdown sequencing requirements and Measurements shows typical measurement data.

Table 1-1. Design Parameters

<table>
<thead>
<tr>
<th>VOLTAGE (V)</th>
<th>RAIL NAME</th>
<th>LOAD CAPABILITY (mA)</th>
<th>SOURCE</th>
<th>STARTUP DELAY (ms)</th>
<th>SHUTDOWN DELAY (ms)</th>
</tr>
</thead>
<tbody>
<tr>
<td>1.8</td>
<td>DDR0_1.8V</td>
<td>300</td>
<td>LP873245-Q1 LDO0</td>
<td>5</td>
<td>15</td>
</tr>
<tr>
<td>1.1</td>
<td>DDR1_1.8V</td>
<td>300</td>
<td>LP873245-Q1 LDO1</td>
<td>5</td>
<td>15</td>
</tr>
<tr>
<td>1.8</td>
<td>VDDQVA_DDR0</td>
<td>2000</td>
<td>LP873245-Q1 Buck0</td>
<td>11</td>
<td>9</td>
</tr>
<tr>
<td>1.8</td>
<td>VDDQVA_DDR1</td>
<td>2000</td>
<td>LP873245-Q1 Buck1</td>
<td>11</td>
<td>9</td>
</tr>
<tr>
<td>1.1</td>
<td>VDDQ18</td>
<td>2000</td>
<td>LP87334A-Q1 Buck0</td>
<td>10</td>
<td>10</td>
</tr>
<tr>
<td>1.8</td>
<td>VDDIO_1V8</td>
<td>300</td>
<td>#1 TLV733P-Q1</td>
<td>2</td>
<td>18</td>
</tr>
<tr>
<td>1.8</td>
<td>VDDQVA_SD1</td>
<td>300</td>
<td>#2 TLV733P-Q1</td>
<td>12</td>
<td>8</td>
</tr>
<tr>
<td>1.8</td>
<td>VDDQVA_SD2</td>
<td>300</td>
<td>#3 TLV733P-Q1</td>
<td>12</td>
<td>8</td>
</tr>
<tr>
<td>1.8</td>
<td>VDDQVA_SD3</td>
<td>300</td>
<td>#4 TLV733P-Q1</td>
<td>12</td>
<td>8</td>
</tr>
<tr>
<td>3.3</td>
<td>VDDQVA_SD0</td>
<td>300</td>
<td>LP87334A-Q1 LDO0</td>
<td>12</td>
<td>8</td>
</tr>
<tr>
<td>3.3</td>
<td>VDDQ33</td>
<td>3000</td>
<td>LP87334A-Q1 Buck1</td>
<td>9</td>
<td>11</td>
</tr>
<tr>
<td>0.9</td>
<td>VDDIO_3V3</td>
<td>300</td>
<td>#5 TLV733P-Q1</td>
<td>2</td>
<td>18</td>
</tr>
<tr>
<td>0.82</td>
<td>VDD_DVFS</td>
<td>8000</td>
<td>LP87565U-Q1 Buck0+1</td>
<td>8</td>
<td>12</td>
</tr>
<tr>
<td>0.82</td>
<td>VDD</td>
<td>8000</td>
<td>LP87565U-Q1 Buck2+3</td>
<td>6</td>
<td>14</td>
</tr>
<tr>
<td>2.5</td>
<td>VDDQ25_ETH</td>
<td>300</td>
<td>LP87334A-Q1 LDO1</td>
<td>10</td>
<td>10</td>
</tr>
<tr>
<td>-</td>
<td>nRESET (PGOOD)</td>
<td>-</td>
<td>PGOOD / LP87565U-Q1 GPIO3</td>
<td>22</td>
<td>0</td>
</tr>
</tbody>
</table>
Figure 2-1 shows an example block diagram of LP87565U-Q1, LP873245-Q1, LP87334A-Q1, and 5 pcs TLV733P-Q1 devices powering the R-Car M3-W power rails.

Main features:

- After the devices are powered, the microcontroller can set the EN pin high to initiate the startup sequence.
- Startup delays are controlled internally in the LP87565U-Q1, LP873245-Q1, and LP87334A-Q1 logic and TLV733P-Q1s are controlled with PMIC GPIOs.
- I2C can be used to read status registers and reset interrupts.
- All PMIC devices have dedicated I2C slave address so they can share the same I2C bus.
- PGOOD signals act as nRESET signal for the SoC and LP87565U-Q1 GPIO2 keeps the signal low at startup for predefined time.
- Voltage control (1.8 V / 3.3 V) VDDQVA_SD0 rail done through I2C bus
- AVS/DVFS support through I2C
3 Sequencing

3.1 Startup

Figure 3-1 shows an example startup timing of the power rails and corresponding signals.

![Figure 3-1. R-Car M3-W Power Startup Timing Diagram](image-url)
3.2 Shutdown

Figure 3-2 shows an example of shutdown timing of the power rails and corresponding signals.

![Figure 3-2. Shutdown Timing Diagram]
4 Schematic

Figure 4-1 through Figure 4-5 show the R-Car M3-W power tree schematic with critical components. Snubbers are needed for LP87565-Q1 when input voltage of the system is >4 V, otherwise they are optional.

Figure 4-1. LP87565-Q1 Schematic

Figure 4-2. LP8732-Q1 Schematic
Figure 4-3. LP8733-Q1 Schematic

Figure 4-4. TLV733P-Q1 LDO Schematic
Figure 4-5. Connections to R-Car M3-W
5 Software Drivers

This solution supports AVS and DVFS for core rail through I^2C bus.

Linux drivers for the LP875x and LP873x are available in public git repository. These can be used to help integrate the LP875x / LP873x control to system software:

LP8756x

- https://github.com/torvalds/linux/blob/master/drivers/mfd/lp87565.c
- https://github.com/torvalds/linux/blob/master/drivers/regulator/lp87565-regulator.c
- https://github.com/torvalds/linux/blob/master/drivers/gpio/gpio-lp87565.c

LP873x

- https://github.com/torvalds/linux/blob/master/drivers/mfd/lp873x.c
- https://github.com/torvalds/linux/blob/master/drivers/regulator/lp873x-regulator.c
- https://github.com/torvalds/linux/blob/master/drivers/gpio/gpio-lp873x.c

Note: Every header file is in the include folder starting from the root directory. So once in include folder, the user can navigate to the relevant header file. For example, the LP87565.h file: https://github.com/torvalds/linux/blob/master/include/linux/mfd/lp87565.h.

See System Solution for more details on the full reference design board and software.
6 System Solution

This section has details on the full reference design board with R-Car M3-W SoC as well as all the peripherals, memory, and connections. This is powered with TI power solution and software has been updated to allow DVFS and AVS control for the core rail power.

Software for the board is based on embedded Linux (Yocto). Full design files, details on the software/driver implementation, and more detailed documentation is available on request. See links below.

General Information on R-Car Software Development

https://elinux.org/R-Car

Design Files, Software, Documentation

https://www.ti.com/licreg/docs/swlicexportcontrol.tsp?form_id=300248&prod_no=LP875X-Q1_LP873X-Q1_TPS65917-Q1_DESIGN_DOCS&ref_url=APP-BMC-IPM

Note: You need to have active ti.com account and request for access for the files. Once your request has been processed and approved, you can download the files from https://www.ti.com/mysecuresoftware.
7 Recommended External Components

Table 7-1 shows the recommended external components to use in this solution with the LP87565-Q1, LP8732-Q1, LP8733-Q1, and TLV-733P-Q1s. It also shows the total solution size, including the PMIC device and the external components.

<table>
<thead>
<tr>
<th>COUNT</th>
<th>VENDOR</th>
<th>PART NUMBER</th>
<th>SYSTEM COMPONENT</th>
<th>UNIT AREA</th>
<th>TOTAL BOARD AREA</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>TI</td>
<td>LP87565URNF RQ1</td>
<td>Configurable 4-phase PMIC</td>
<td>W (mm)</td>
<td>H (mm)</td>
</tr>
<tr>
<td>4</td>
<td>Murata</td>
<td>DFE252012PD-R47M</td>
<td>LP87565 Inductor 0.47 µH, Imax 4.0 A, Rdc typ 21mΩ</td>
<td>2.50</td>
<td>1.20</td>
</tr>
<tr>
<td>4</td>
<td>Murata</td>
<td>GCM21BR71A 108KE22</td>
<td>LP87565 SMPS Input Capacitor 10 µF, 10 V, 10%</td>
<td>2.00</td>
<td>1.25</td>
</tr>
<tr>
<td>4</td>
<td>Murata</td>
<td>GCM31CR71A 226KE02</td>
<td>LP87565 SMPS Output Capacitor 22 µF, 10 V, 10%</td>
<td>3.20</td>
<td>1.80</td>
</tr>
<tr>
<td>13</td>
<td>Murata</td>
<td>GRT31CC80J4 76KE13</td>
<td>Point of load Capacitor 47 µF, 6.3 V, 10%,</td>
<td>3.20</td>
<td>1.60</td>
</tr>
<tr>
<td>4</td>
<td>Murata</td>
<td>GCM188R71C 104KA55D</td>
<td>LP87565 Input Capacitor 0.1 µF, 16 V, 10%</td>
<td>1.00</td>
<td>0.50</td>
</tr>
<tr>
<td>4</td>
<td>Murata</td>
<td>GCM188R71C 25KE22</td>
<td>LP87565 LDO Input Capacitor 2.2 µF, 6.3 V, 10%</td>
<td>1.60</td>
<td>0.80</td>
</tr>
<tr>
<td>4</td>
<td>Murata</td>
<td>GCM188R71C 105KA64</td>
<td>LP87565 LDO Output Capacitor 1.0 µF, 16 V, 10%</td>
<td>1.60</td>
<td>0.80</td>
</tr>
<tr>
<td>4</td>
<td>Murata</td>
<td>GCM188R71C 104KA55D</td>
<td>LP87565 Input Capacitor 0.1 µF, 16 V, 10%</td>
<td>1.00</td>
<td>0.50</td>
</tr>
<tr>
<td>4</td>
<td>TI</td>
<td>TLV733P-Q1</td>
<td>TLV733P-Q1 Low Dropout Regulator</td>
<td>2.00</td>
<td>0.80</td>
</tr>
<tr>
<td>4</td>
<td>Murata</td>
<td>GCM155R71C 104KA55D</td>
<td>TLV733P-Q1 Input Capacitor 0.1 µF, 16 V, 10%</td>
<td>1.00</td>
<td>0.50</td>
</tr>
<tr>
<td>4</td>
<td>Murata</td>
<td>GCM155R71C 104KA55D</td>
<td>TLV733P-Q1 Output Capacitor 0.1 µF, 16 V, 10%</td>
<td>1.00</td>
<td>0.50</td>
</tr>
</tbody>
</table>

Note: Assuming 1 mm keep-out around each component, and multiplying by component count

Routing area calculated with 0.3 routing factor: 261.11 mm²

Total area: 870.37 mm²
8 Measurements

Test data can be found in the Application Curves section of the LP8756x-Q1 16A Buck Converter With Integrated Switches Data Sheet, LP8732xx-Q1 Dual High-Current Buck Converter and Dual Linear Regulator Data Sheet, and the LP8733xx-Q1 Dual High-Current Buck Converter and Dual Linear Regulator Data Sheet.

Additional bench test data for efficiency in specific conditions for this power tree can be seen in this section.

Measurements were taken on the LP87565Q1EVM and LP8733Q1EVM with default components.

Figure 8-1. LP87565-Q1 Efficiency with Vin = 5 V, 25°C, Vout = 0.85 V

Figure 8-2. LP8732-Q1/LP8733-Q1 Efficiency with Vin = 5 V, 25°C
9 Summary

With this presented solution with the LP87565-Q1, LP8732-Q1, and LP8733-Q1 PMICs, it is possible to meet power requirements for R-Car M3 application processor while maintaining good efficiency. Sequencing is handled in PMICs and only one EN signal is needed from the controller. Solution is compact due to minimum number of external components. I²C control allows AVS and DVFS for core rails. Design files for the development platform including hardware, software, and detailed documentation are available on request.
10 References

See these references for additional information:

1. Texas Instruments, *LP8756x-Q1 16A Buck Converter With IntegratedSwitches Data Sheet* (SNVSB22)
3. Texas Instruments, *LP8732xx-Q1 Dual High-Current Buck Converter and Dual Linear Regulator Data Sheet* (SNVSB63)
5. Texas Instruments, *LP8733xx-Q1 Dual High-Current Buck Converter and Dual Linear Regulator Data Sheet* (SNVSB64)
7. Texas Instruments, *LP8756x-Q1 Configuration Guide* (SNVU590)
8. Texas Instruments, *LP8733-Q1 and LP8732-Q1 Configuration Guide* (SNVU582)

11 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

<table>
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<th>Changes from Revision * (May 2019) to Revision A (October 2021)</th>
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<tr>
<td>• Updated abstract to include full part numbers and information about full reference design availability</td>
<td>1</td>
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<tr>
<td>• Updated design parameters with full part numbers. Updated load currents</td>
<td>3</td>
</tr>
<tr>
<td>• Updated block diagram to include full part numbers</td>
<td>4</td>
</tr>
<tr>
<td>• Updated sequencing part numbers for PMICs</td>
<td>5</td>
</tr>
<tr>
<td>• Updated Schematic with full part numbers</td>
<td>7</td>
</tr>
<tr>
<td>• Updated Software Drivers to include link to System Solution section</td>
<td>10</td>
</tr>
<tr>
<td>• Added System solution section</td>
<td>11</td>
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<tr>
<td>• Updated Recommended External Components PMIC part numbers</td>
<td>12</td>
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<tr>
<td>• Added link to LP8733-Q1 datasheet in Measurement section</td>
<td>13</td>
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<tr>
<td>• Updated Summary to include LP8733-Q1 and added note about reference design files</td>
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<tr>
<td>• Updated reference links to include LP8733-Q1 datasheet, LP87565U-Q1 TRM, LP873245-Q1 TRM, and LP87334A-Q1 TRM</td>
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